High Current Molded Power Inductor - PA4346.XXXANLT Series



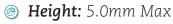












Footprint: 14.0mm x 12.8mm Max

@ Current Rating: up to 50A

Inductance Range: 0.22uH to 68uH

Shielded construction and compact design

High current, low DCR, and high efficiency

Minimized acoustic noise and minimized leakage flux

200 Vdc Isolation between terminal and core

	Elect	rical Specification	ns @ 25°C - Oper	ating Temperatu	re -55°C to +155°C			
Part	☐!nductance ^{5,8}	Rated ³ Current		DC stance	Saturation ² Current	SRF		K Factor
Number	100KHz, 1V		TYP.	MAX.	TYP.	TPY.	Mechanical	
	uH±20%	A	mΩ	mΩ	A	MHz]	
PA4346.221ANLT	0.22	50.0	0.50	0.61	60.0	111	Footprint 1	104.6
PA4346.331ANLT	0.33	37.0	0.65	0.80	59.0	90	Footprint 1	
PA4346.361ANLT	0.36	36.0	0.68	0.84	59.0	72	Footprint 1	
PA4346.391ANLT	0.39	35.0	0.74	0.87	58.0	72	Footprint 1	
PA4346.471ANLT	0.47	34.0	0.77	0.90	58.0	63	Footprint 1	67.9
PA4346.501ANLT	0.50	33.0	0.95	1.10	55.0	60	Footprint 1	
PA4346.561ANLT	0.56	32.5	1.10	1.30	50.0	57	Footprint 1	
PA4346.681ANLT	0.68	31.0	1.30	1.55	42.0	52	Footprint 1	75.8
PA4346.821ANLT	0.82	29.0	1.40	1.70	38.0	48	Footprint 1	68.7
PA4346.102ANLT	1.00	27.0	1.60	1.90	34.0	38	Footprint 1	53.5
PA4346.122ANLT	1.20	24.0	2.40	2.80	30.0	31	Footprint 2	
PA4346.152ANLT	1.50	22.0	3.20	3.80	28.0	29	Footprint 2	43.7
PA4346.182ANLT	1.80	19.0	3.70	4.30	25.0	26	Footprint 2	
PA4346.222ANLT	2.20	15.5	4.1	4.80	23.0	21	Footprint 2	28.3
PA4346.332ANLT	3.30	14.0	6.0	7.00	20.5	17	Footprint 2	20.9
PA4346.472ANLT	4.70	12.5	8.8	10.2	16.0	14	Footprint 2	14.8
PA4346.562ANLT	5.60	12.0	10.0	12.0	15.5	12	Footprint 2	13.9
PA4346.602ANLT	6.00	11.5	12.5	15.0	15.2	11.5	Footprint	
PA4346.682ANLT	6.80	11.0	13.0	16.0	15.0	11	Footprint 2	12.4
PA4346.822ANLT	8.20	10.0	15.0	18.0	12.0	10	Footprint 2	10.5
PA4346.103ANLT	10.0	9.0	19.2	22.0	10.5	9	Footprint 2	13.6
PA4346.153ANLT	15.0	8.2	30.0	36.0	9.2	8	Footprint 2	10.4
PA4346.223ANLT	22.0	7.0	42.0	52.0	7.5	7	Footprint 2	9.2

PulseElectronics.com P797.G (08/23)

High Current Molded Power Inductor - PA4346.XXXANLT Series



Electrical Specifications @ 25°C - Operating Temperature -55°C to +155°C										
Part Number	Inductance ^{5,8} 100KHz, 1V	Rated³ Current		C tance	Saturation ² Current	SRF	Mechanical	K Factor		
			TYP.	MAX.	TYP.	TPY.				
	uH±20%	A	mΩ	mΩ	A	MHz				
PA4346.333ANLT	33	5.2	66	80	6.5	6	Footprint 2	6.5		
PA4346.473ANLT	47	4.3	78	94	5.2	5	Footprint 2	5.5		
PA4346.683ANLT	68	3.6	110	132	4.4	3	Footprint 2	4.4		

Notes:

- Actual temperature of the component during system operation (ambient plus temperature rise) must be within the standard operating range.
- The saturation current is the current at which the initial inductance drops by approximately 30% at the stated ambient temperature. The maximum allowable drop at this stated current is 40% of the initial inductance. This current is determined by placing the component in the specified ambient environment and applying a short duration pulse current (to eliminate self-heating effect) to the component.
- 3. The rated current is the DC current required to raise the component temperature by approximately 40°C. Take note that the components' performanc varies depending on the system condition. It is suggested that the component be tested at the system level, to verify the temperature rise of the component during system operation.
- 4. The part temperature (ambient+temp rise) should not exceed maximum operating temperature under worst case operating conditions. Circuit design, PCB trace size and

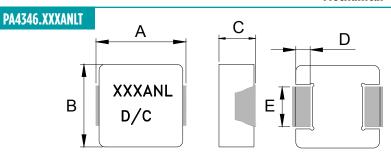
- thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.
- Please note that the inductance tolerance of all parts are ±20%, except those indicated by an * which are +/- 30%.
- Parts shown in bold are standard catalog parts and are available through sample stock and distribution. Parts in lighter font are available but are not necessarily held in sample stock or distribution and lead times may be longer. Please contact Pulse for availablity.
- 7. The mechanical dimensions are 100% tested in production but do not necessarily meet a product capability index (Cpk) 1.33 and therefore may not strictly conform to PPAP.
- 8. Special Characteristics 🗇

PulseElectronics.com P797.G (08/23)

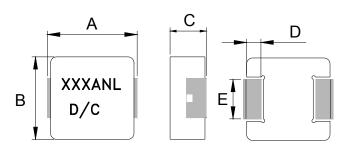
High Current Molded Power Inductor - PA4346.XXXANLT Series

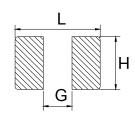


Mechanical



Footprint 1





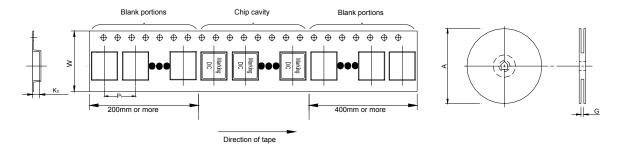
Footprint 2
Final Layout

SUGGESTED PAD LAYOUT

Series	Mechanical	A	В	C	D	E	l	G	Н
PA4346.XXXANLT	Footprint 1	13.5 ±0.5	12.6±0.2	4.7±0.3	2.3±0.3	4.0±0.3	14.5	8.0	5.0
PA4346.XXXANLT	Footprint 2	13.5 ±0.5	12.6±0.2	4.7±0.3	2.3±0.3	4.7±0.3	14.5	8.0	5.0

All Dimensions in mm.

TAPE & REEL INFO



SURFACE MOUNTING TYPE, REEL/TAPE LIST									
FVDF	REEL SIZ	'E (mm)	TA	QTY					
FYPE	A	G	P ₁	W	$K_{_{0}}$	PCS/REEL			
PA4346.XXXANLT	Ø330	24.4	16	24	5.5	500			

PulseElectronics.com P797.G (08/23)

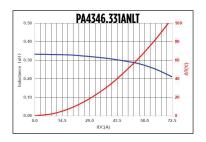
3

High Current Molded Power Inductor - PA4346.XXXANLT Series

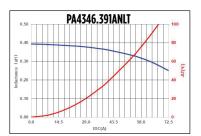


Typical Performance Curves

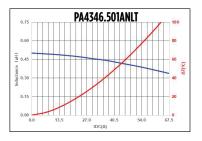


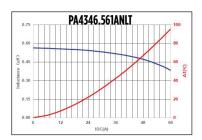


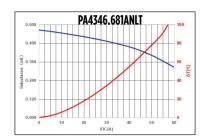


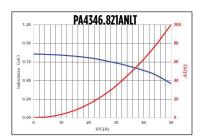


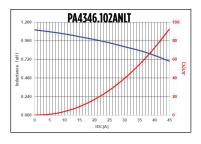






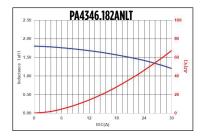




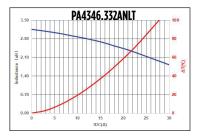










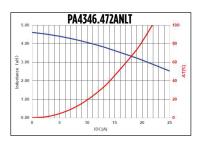


PulseElectronics.com

P797.G (08/23)

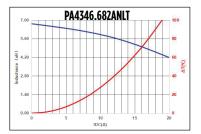
High Current Molded Power Inductor - PA4346.XXXANLT Series



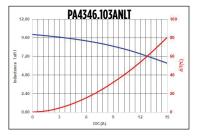


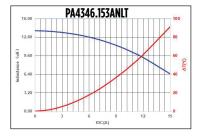




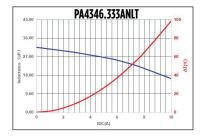


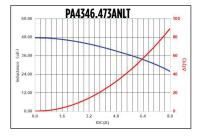


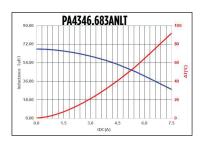








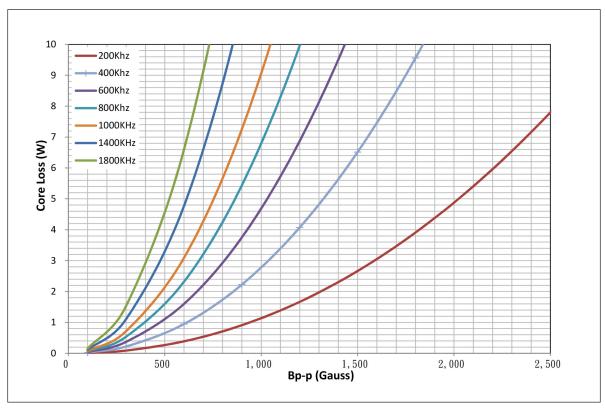




PulseElectronics.com P797.G (08/23)

High Current Molded Power Inductor - PA4346.XXXANLT Series

Core Loss



Bp-p = K *L(uH) *delta I(A)

For More Information:

6

Americas - prodinfo_power_americas@yageo.com | Europe - prodinfo_power_emea@yageo.com | Asia - prodinfo_power_asia@yageo.com

Performance warranty of products offered on this data sheet is limited to the parameters specified. Data is subject to change without notice. Other brand and product names mentioned herein may be trademarks or registered trademarks of their respective owners. © Copyright, 2023. Pulse Electronics, Inc. All rights reserved.

YAGEO Corporation and its affiliates do not recommend the use of commercial or automotive grade products for high reliability applications or manned space flight.

